

## INCREASED EFFICIENCY IN LIQUID AND GASSEOUS PLANAR DEVICE COOLING TECHNOLOGY

**That my residence, county, post office address and citizenship are as stated below next to my name;**

**That I acknowledge the duty to disclose information which is material to the patentability of the above identified patent application in accordance with Title 37 Code of Federal Regulations, Section 1.56;**

That all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true ; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that willful false statements may jeopardize the validity of the application or any patent issued thereon.

Manny W. Schechter (Reg. No. 31,722), Lauren C. Bruzzone (Reg. 35,082), Christopher A. Hughes (Reg. 26,914), Edward A. Pennington (Reg. No. 32,588), John E. Hoel (Reg. No. 26,279), Joseph C. Redmond Jr. (Reg. No. 18,753) Stephen C. Kaufman (Reg. No. 29,551), Jay P. Sbrollini (Reg. No. 36,266), David M. Shofi (Reg. No. 39,835), Robert M. Trepp (Reg. No. 25,933), Louis P. Herzberg (Reg. No. 41,500), Daniel P. Morris (Reg. No. 32,053), Paul J. Otterstedt (Reg. 37,411). Louis J. Percello (Reg. No. 33,206), Douglas W. Cameron (Reg. No. 31,596), Marian Underweiser (Reg. No. 46,134), Richard M. Ludwin (Reg. No. 33,010) and Marc A. Erlich (Reg. No. 39,966).

**Send correspondence to     Alvin J. Riddles**  
**Box 34, Candlewood Isle**  
**New Fairfield, Ct. 06812**  
**Direct Telephone Calls to (914) 472-0644   (203) 746-3470**

**Lawrence Shungwei Mok**  
Full Name of first inventor

11/29/2000

## USA

**Same as above**

Tsorng-Dih Yuan

**Full Name of second inventor**

12/03/2000

USA

**Same as above**

**Second Inventor's Post Office Address**

**END OF DECLARATION**

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**For: INCREASED EFFICIENCY IN LIQUID AND GASEOUS  
PLANAR DEVICE COOLING TECHNOLOGY**

**Commissioner of Patents and Trademarks**  
**Washington, D.C. 20231**  
**Sir:**

**Please Direct all correspondence to:**

~~Respectfully submitted.~~

by

11-27-2002

**IBM Corporation**  
**Intellectual Property Law Dept.**  
**Box 218**  
**Yorktown Heights, N.Y. 10598**  
**(914) 945-3197**